

330V, PDP IGBT

- Features
- High current capability
- Low saturation voltage: V_{CE (sat)} =1.55 V @ IC = 50 A
- High input impedance
- Fast switching
- RoHS compliant

Applications

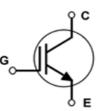
PDP System



General Description

Using Novel Trench IGBT Technology, Fairchild's new series of trench IGBTs offer the optimum performance for PDP applications where low conduction and switching losses are essential.





Absolute Maximum Ratings

Symbol	Description		Ratings	Units
V _{CES}	Collector to Emitter Voltage		330	V
V _{GES}	Gate to Emitter Voltage		± 30	V
I _{C pulse(1)*}	Collector Current	@ T _C = 25°C	200	А
P _D	Maximum Power Dissipation	@ T _C = 25°C	28.4	W
١D	Maximum Power Dissipation	@ T _C = 100 ^o C	11.4	W
TJ	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$ (IGBT)	T) Thermal Resistance, Junction to Case		4.4	°C/W
R_{\thetaJA}	A Thermal Resistance, Junction to Ambient		62.5	°C/W

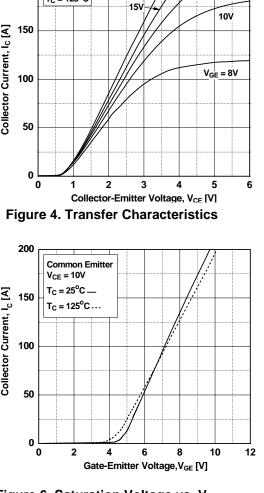
Notes:

(1) Half Sine Wave, D < 0.01, pluse width < 5 μ sec * lc_pluse limited by max Tj

August 2010

FGPF4 Electrica Symbol Off Charact BV _{CES} Δ BV _{CES} Δ T _J	al Char eristics Collector t Temperatu Voltage Collector (FGPF4533TU acteristics of the Parameter o Emitter Breakdown Voltagure Coefficient of Breakdow	Test	Tube 5°C unless otherwise noted Conditions	50 Min.	Typ.	Max.	- Units
Symbol Off Charact BV _{CES} Δ BV _{CES} Δ T _J	collector t Temperatu Voltage Collector (Parameter	Test		Min.	Тур.	Max.	Units
Symbol Off Charact BV _{CES} Δ BV _{CES} Δ T _J	collector t Temperatu Voltage Collector (Parameter	Test		Min.	Тур.	Max.	Units
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BV _{CES} ΔBV _{CES} ΔT _J	Collector t Temperatu Voltage Collector (-	e V _{GE} = 0V, I _C					
ΔBV _{CES} ΔT _J	Temperatu Voltage Collector (-	02 0	2 = 250μΑ	330	-	-	V
I _{CES}			$V_{GE} = 0V, I_C$	$V_{GE} = 0V, I_C = 250\mu A$		0.3	-	V/ºC
		Cut-Off Current	$V_{CE} = V_{CES}$	$V_{CE} = V_{CES}, V_{GE} = 0V$		-	100	μA
I _{GES}	G-E Leaka	G-E Leakage Current		$V_{GE} = V_{GES}, V_{CE} = 0V$		-	±400	nA
On Charact	oriotico							
	G-E Threshold Voltage		I _C = 250μA,	V _{CE} = V _{CE}	2.4	3.3	4.0	V
GE(III)			$I_{\rm C} = 20$ A, V _G		_	1.15	-	V
			$I_{\rm C} = 50$ A, $V_{\rm G}$ $T_{\rm C} = 25^{\circ}$ C		-	1.55	1.8	V
			$I_{\rm C} = 50$ A, $V_{\rm G}$ $T_{\rm C} = 125^{\rm o}$ C	_{SE} = 15V,	-	1.6	-	V
	haraataria	lies					I	1
Dynamic Cł C _{ies}	Input Cap					1294	-	pF
C _{oes}	Output Capacitance			$V_{CE} = 30V, V_{GE} = 0V,$		57	-	pF
	•	ransfer Capacitance	f = 1MHz	f = 1MHz		41	-	pF
Switching C								
t _{d(on)}		Delay Time	V _{CC} = 200V,	$l_{c} = 20A$	-	6	-	ns
t _r	Rise Time		$-R_{G} = 5\Omega, V_{G}$	_{GE} = 15V	-	22	-	ns
t _{d(off)}		Delay Time	ResistiveLoa	ad,T _C =25°C	-	40	-	ns
	Fall Time	· · -			-	220	-	ns
t _{d(on)}		Delay Time	Vac - 200V	$l_{0} = 20A$	-	6	-	ns
t _r	Rise Time		$R_{G} = 5\Omega, V_{G}$	V _{CC} = 200V, I _C = 20A, R _G = 5Ω, V _{GE} = 15V,		24	-	ns
t _{d(off)}		Delay Time		bad, $T_C = 125^{\circ}C$	-	42	-	ns
t _f	Fall Time				-	277	-	ns
Qg	Total Gate	•		I _C = 20A	-	44	-	nC
Q _{ge}	Gate to Er	mitter Charge	$V_{GE} = 15V$		-	6	-	nC

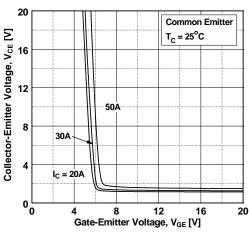
查询"FGPF4533"供应商 **Typical Performance Characteristics Figure 1. Typical Output Characteristics Figure 2. Typical Output Characteristics** 200 200 12V T_C = 25^oC 20V 10V T_C = 125^oC 15V Collector Current, I_c [A] 00 00 00 150 Collector Current, I_c [A] $V_{GE} = 8V$ 100 50 0 0 0 2 3 4 5 0 6 1 Collector-Emitter Voltage, V_{CE} [V] **Figure 3. Typical Saturation Voltage** Characteristics 200 200 Common Emitter $V_{GE} = 15V$ $T_{C} = 25^{\circ}C$ — Collector Current, I_c [A] Collector Current, I_c [A] 05 00 00 051 150 T_C = 125^oC ... 100 50 0 0 0 1 2 3 4 5 0 Collector-Emitter Voltage, V_{CE} [V] Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level 1.7 20 Common Emitter Collector-Emitter Voltage, V_{CE} [V] V_{GE} = 15V 16 50A 12 30A 8 I_C = 20A 4 0 ∟ 0 1.0 0 20 40 60 100 120 140 80 Collector-EmitterCase Temperature, T_C [°C]



20V-

. 12V

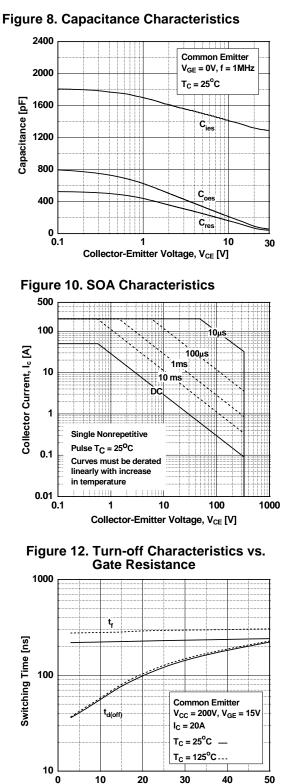
Figure 6. Saturation Voltage vs. V_{GE}



FGPF4533 Rev. B

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查询"FGPF4533"供应商 **Typical Performance Characteristics** Figure 7. Saturation Voltage vs. V_{GE} 20 Common Emitter $T_{C} = 125^{\circ}C$ Collector-Emitter Voltage, V_{CE} [V] 16 12 50A 8 30A 4 I_C = 20A 0 0 4 8 12 16 20 Gate-Emitter Voltage, V_{GE} [V] **Figure 9. Gate charge Characteristics** 15 Common Emitter $T_C = 25^{\circ}C$ $V_{CC} = 100V$ 200V 0 15 30 45 0 Gate Charge, Q_g [nC] Figure 11. Turn-on Characteristics vs. **Gate Resistance** 100 Switching Time [ns] 10 Common Emitter d(on) V_{CC} = 200V, V_{GE} = 15V I_C = 20A $T_{C} = 25^{\circ}C$ — T_C = 125°C 1 0 10 20 30 40 50 Gate Resistance, R_G [Ω]



Gate Resistance, R_G [Ω]



查询"FGPF4533"供应商 **Typical Performance Characteristics** Figure 13. Turn-on Characteristics vs. **Collector Current** 100 ť Switching Time [ns] 10 t_{d(on)} Common Emitter $V_{GE} = 15V, R_G = 5\Omega$ $T_{c} = 25^{\circ}C$ — T_C = 125°C ... 1 30 10 20 40 50 Collector Current, I_C [A] Figure 15. Switching Loss vs. Gate Resistance 5000 Common Emitter V_{CC} = 200V, V_{GE} = 15V I_C = 20A 1000 T_C = 25°C ____ T_C = 125^oC.... Eoff

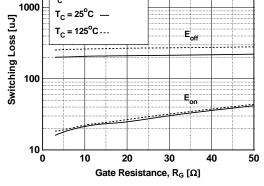


Figure 17. Turn off Switching SOA Characteristics

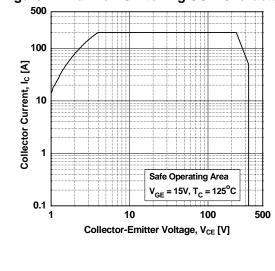
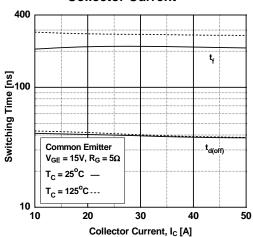
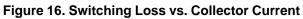
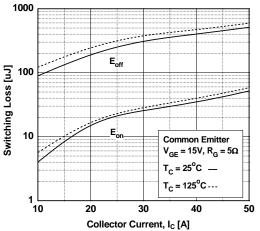
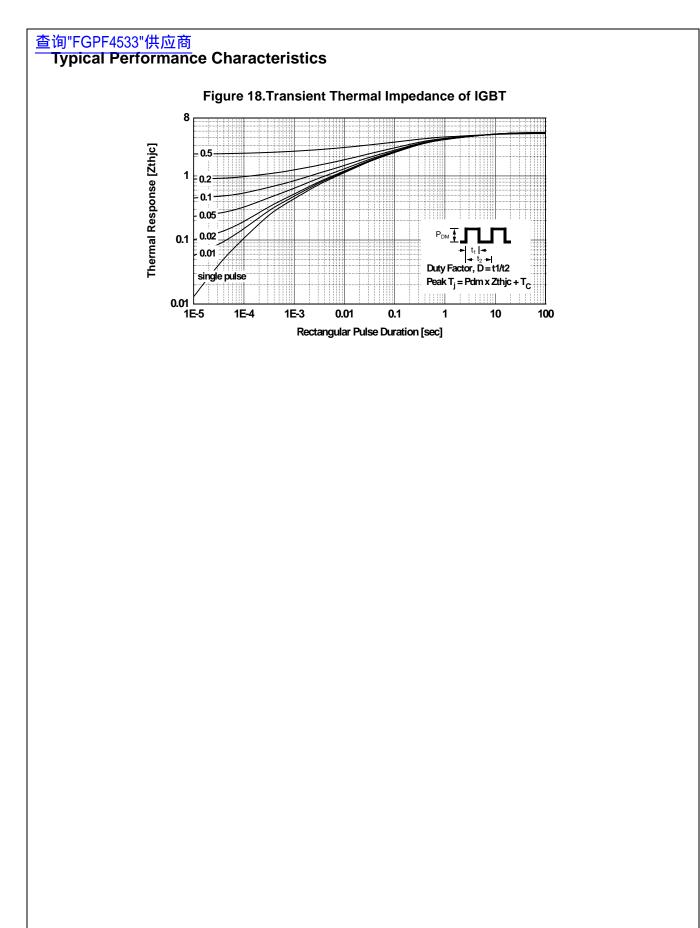


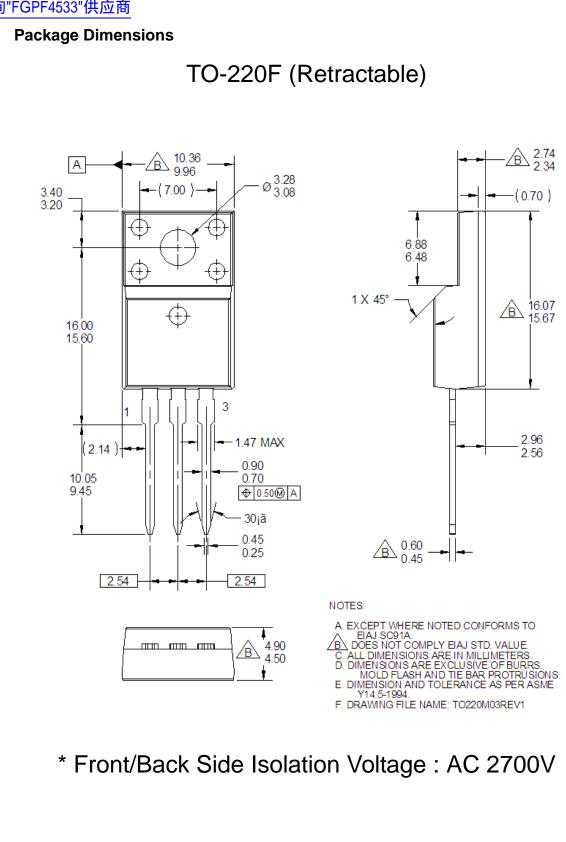
Figure 14. Turn-off Characteristics vs. Collector Current











Dimensions in Millimeters

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